C. Samsung Reliablility Test and Judgement Condition

Capacitance Within specified tolerance 120Hz ±20% / 0.5±0.1Vrms *A capacitor prior to measuring the capacitance treated at 150 ℃ +0/-10 ℃ for 1 hour and maintal ambient air for 24±2 hours. Insulation 10,000Mohm or 50Mohm×μF Rated Voltage 60~120 sec. Resistance Whichever is smaller Appearance No abnormal exterior appearance Microscope (×10) Withstanding No dielectric breakdown or mechanical breakdown 250% of the rated voltage Voltage mechanical breakdown	
Tan δ (DF) 0.1 max. treated at 150 °C +0/-10 °C for 1 hour and maintal ambient air for 24±2 hours. Insulation 10,000Mohm or 50Mohm×μF Rated Voltage 60~120 sec. Resistance Whichever is smaller Appearance No abnormal exterior appearance Microscope (×10) Withstanding No dielectric breakdown or wechanical breakdown 250% of the rated voltage Temperature X5R	
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Voltage mechanical breakdown Temperature X5R	
Temperature X5R	
Characteristics (From-55 ℃ to 85 ℃, Capacitance change should be within ±15%)	
Adhesive Strength No peeling shall be occur on the 500g·f, for 10±1 sec.	
of Termination terminal electrode	
Bending Strength Capacitance change: within ±12.5% Bending to the limit (1mm)	
with 1.0mm/sec.	
Solderability More than 75% of terminal surface SnAg3.0Cu0.5 solder	
is to be soldered newly 245±5°C, 3±0.3sec.	
(preheating : 80~120°C for 10~30sec.)	
Resistance to Capacitance change: within ±7.5% Solder pot: 270±5°C, 10±1sec.	
Soldering Heat Tan δ, IR : initial spec.	
Vibration TestCapacitance change : within \pm 5%Amplitude : 1.5mmTan δ, IR : initial spec.From 10Hz to 55Hz (return : 1min.)2hours \times 3 direction (x, y, z)	
Moisture Capacitance change: within ±12.5% With rated voltage	
Resistance Tan δ : 0.25 max 40±2°C, 90~95%RH, 500+12/-0hrs	
IR : 500Mohm or 3.5Mohm × μ F Whichever is smaller	
High Temperature Capacitance change: within ±12.5% With 150% of the rated voltage	
Resistance Tan δ : 0.25 max Max. operating temperature	
IR: 1,000Mohm or 7Mohm × μ F 1,000+48/-0hrs	
Whichever is smaller	
Temperature Capacitance change: within ±15% 1 cycle condition	
→ Max. operating temperature → 25°C	
5 cycle test	

^{**} The reliability test condition can be replaced by the corresponding accelerated test condition.

D. Recommended Soldering method :

Reflow (Reflow Peak Temperature : 260±5°C, 30sec.)



Product specifications included in the specifications are effective as of March 1, 2013.

Please be advised that they are standard product specifications for reference only.

We may change, modify or discontinue the product specifications without notice at any time.

So, you need to approve the product specifications before placing an order.

Should you have any question regarding the product specifications,

please contact our sales personnel or application engineers.

- Disclaimer & Limitation of Use and Application -

The products listed in this Specification sheet are **NOT** designed and manufactured for any use and applications set forth below.

Please note that any misuse of the products deviating from products specifications or information provided in this Spec sheet may cause serious property damages or personal injury.

We will **NOT** be liable for any damages resulting from any misuse of the products, specifically including using the products for high reliability applications as listed below.

If you have any questions regarding this 'Limitation of Use and Application', you should first contact our sales personnel or application engineers.

- ① Aerospace/Aviation equipment
- ② Automotive or Transportation equipment (vehicles, trains, ships, etc)
- 3 Medical equipment
- Military equipment
- 5 Disaster prevention/crime prevention equipment
- *⑤* Any other applications with the same as or similar complexity or reliability to the applications set forth above.